

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
PEDRO MORALES	11/26/2014
DOMINIK SEYFRIED	11/26/2014
THEKLA WÜTSCHKE	11/25/2014
ANTON SHU	11/27/2014
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<b>Postal Code:</b>	D-78532
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	29510163
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<b>ATTORNEY DOCKET NUMBER:</b>	5031-0409
<b>NAME OF SUBMITTER:</b>	AJIT J. VAIDYA
<b>SIGNATURE:</b>	/ajit j. vaidya/
<b>DATE SIGNED:</b>	12/11/2014
<b>Total Attachments: 3</b>	
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## ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

## HEART POSITIONER

for which WE executed an application for a United States Design Patent concurrently herewith and for which WE obtained Registration No. 002470765-0001 from the Office of Harmonization in the Internal Market (OHIM) on May 26, 2014; and

WHEREAS Aesculap AG, a corporation of Germany, whose post office address is Am Aesculap-Platz, D-78532, Tuttlingen, Germany (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Design Patent on this invention and the Design Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Design Patents of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Design Patent which may hereafter be filed for this invention in any foreign country and all Design Patents which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Design Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;


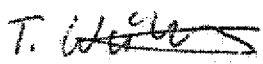
AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper design patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. 29/510,163, filed Nov. 25, 2014) the filing date and application number of said application when known.


IN TESTIMONY WHEREOF, I have hereunto set my hand.

Full Name of First Assignor <b>Pedro MORALES</b>	Assignor's Signature <i>Pedro Morales</i>	Date <i>26.11.2014</i>
Address: Fronhofstr. 26 78532, Tuttlingen, Germany		Citizenship Germany
Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		

KENEALY VAIDYA LLP

<u>Full Name of Second Assignor</u> Dominik SEYFRIED	<u>Assignor's Signature</u> 	<u>Date</u> 26.11.2014
<u>Address:</u> Rotwaldstr. 15 78126, Königsfeld, Germany		<u>Citizenship:</u> Germany
<u>Full Name of Third Assignor</u> Thekla WÜTSCHKE	<u>Assignor's Signature</u> 	<u>Date</u> 25.11.14
<u>Address:</u> Pommernweg 2 73066, Uhingen, Germany		<u>Citizenship:</u> Germany
<u>Full Name of Fourth Assignor</u> Anton SHU	<u>Assignor's Signature</u>	<u>Date</u>
<u>Address:</u> Jasperallee 30 81245, München, Germany		<u>Citizenship:</u> Germany
<p>Names of additional inventors attached    <input type="checkbox"/> Yes    <input checked="" type="checkbox"/> No</p>		

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<u>Full Name of Second Assignor</u> <b>Dominik SEYFRIED</b>	<u>Assignor's Signature</u>	<u>Date</u>
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<p align="center">Names of additional inventors attached    <input type="checkbox"/> Yes    <input checked="" type="checkbox"/> No</p>		

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